

#### MAINTENANCE MANUAL

### 138-174 MHz, 65 WATT POWER AMPLIFIER

### 19D424583G3 MOBILE "M" SERIES AND INTERMITTENT DUTY STATION

#### 19D424583G7 MOBILE "E" SERIES

### 19D424786G3 CONTINUOUS DUTY STATION

### 19D424786G6 CONTINUOUS DUTY DUPLEX

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#### DESCRIPTION

The MASTR® II modularized 65-Watt PA assembly contains a 25-Watt driver module, a 65-Watt PA module, power control circuitry and low pass filter. A total of three transistors, two in the 25-Watt driver and one in the 65-Watt PA, are used to provide 65 watts RF output power. The output power is adjustable from 13 watts to rated output power and is held constant for normal variations in temperature and voltage.

- CAUTION -

Mobile and Station Power Amplifier Assemblies ARE NOT interchangeable due to different chassis grounding requirements.

However, the individual driver and power amplifier board may be interchanged between mobiles and stations.

Supply voltage for the PA is connected through power leads from the system board to feedthrough capacitors C297 and C298 on the bottom of the PA assembly. C297, C298, C299 and L201 prevent RF from getting on the power leads. Diode CR295 will cause the main fuse in the fuse assembly to blow if the polarity of the power leads is reversed, providing reverse voltage protection for the radio.

The PA assembly is insulated from vehicle ground to permit operation in positive or negative ground vehicles.

- NOTE -

In positive ground vehicles, A - is "hot" with respect to vehicle ground. Shorting the transmitter PA printed wiring board ground pattern to the radio case may cause one of the inline fuses to blow.

Centralized metering jack J205 is provided for use with GE Test Set Model 4EX3A11 or Test Kit 4EX8K12. The Test Set meters Ampl-1 drive (exciter output), power control voltage, driver, and PA current.

### CIRCUIT ANALYSIS

### 25-WATT DRIVER A202

The exciter output is coupled through an RF cable to PA input jack J201. The RF is coupled through a matching network to the base of Class C amplifier Q1. The coupling network matches the 50 ohm input to the base of Q1 and consists of A202-T1, C5, and C39. R3, C3, R13 and L1 are stabilizing networks in the base circuit of Q1.

Part of the RF input is rectified by CR1 and is applied to voltage divider R1

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and R2. The voltage is divided to activate the Power Control circuits and for metering the Ampl-1 drive at J205.

Collector voltage to Q1 is controlled by the Power Control circuit, and is applied to Q1 through collector stabilizing network L4 and R4 and collector feed network L3 and C6. The collector voltage is metered through R7 at J205-3 (Pos. C).

The output of Q1 is coupled to the base of the second class C amplifier Q2 through a matching network consisting of C10, C12, C13, C14 and L5 through L7. Collector voltage to Q2 is applied through collector stabilizing network L11 and R6 and collector feed network L8 and C15.

The output of the 25-Watt driver is taken from the collector of Q2 and applied to the base of power amplifier A205-Q1 on the 65-Watt PA module through an impedance matching network, two 50 ohm micro strips, W30 and a second impedance matching network.

The collector impedance matching network for A202-Q2 (L9, L10, C19, C20 and C21) matches the output of Q2 to 50 ohm micro strip A202-W2. C22 is a DC blocking capacitor. W30 interconnects the output of the 25-Watt driver to the input of the 65-Watt PA module A205.

### 65-WATT PA MODULE A205

The base impedance matching network for A205-Q1 (L1-L3, C1-C4, and R1) matches the 50 ohm input impedance to the base of A205-Q1. Collector voltage is coupled through collector stabilizing network Z1 and collector feed network L4 and C5.

Collector current for A205-Q1 is metered across tapped manganin resistor R15 at J205-5&6. The reading is taken on the 10-volt scale with the High Sensitivity button pressed and read as 10 amperes full scale.

Following A205-Q1 is an impedance matching network consisting of (L4, L6 and C5 through C9) that matches the output of A205-Q1 to 50 ohm micro strip W2. The RF energy is then coupled through W31 and the low pass filter to the antenna.

### - WARNING -

The RF Power Transistors used in the transmitter contain Beryllium Oxide, a TOXIC substance. If the ceramic, or other encapsulation is opened, crushed, broken or abraded, the dust may be hazardous if inhaled. Use care in replacing transistors of this type.

#### POWER CONTROL CIRCUIT

The power control circuit, located on the 25-Watt driver module and the PA Assembly, consists of power control IC A202-U1, thermistor RT201, power adjust potentiometer A202-R8, pass transistor Q215 and the directional coupler. The power control IC senses the presence of drive power from the exciter, the heatsink temperature, power output level, reflected power, and input voltage to provide automatic power leveling across the frequency band.

When the transmitter is keyed, rectified RF from A202-CR1 is applied to pin 10 of U1, turning it on. U1 supplies a reference voltage through pin 4 to power adjust potentiometer A202-R8. The voltage appearing at the arm of R8 is applied back to pin 2 of U1. This voltage determines the base voltage of Q215. The conduction of Q215 sets the collector voltage for AMPL-1, A202-Q1, thereby controlling the RF drive to the PA. The RF output power varies in direct proportion to the RF drive applied to the PA and can be adjusted from approximately 13 to 65 watts.

Once the power is set to the desired level, U1 compares the setting of power adjust control R8 to the actual output power flowing through the directional coupler and adjusts the collector voltage on A202-Q1 accordingly. A205-CR1 rectifies the sensed forward power from the directional coupler and A205-R2 sets the forward power reference voltage applied to pin 2 of U1.

Reflected power is sensed by the directional coupler and rectified by A205-CR2. When the reflected power exceeds a preset level established by A205-R3, a DC voltage proportional to the reflected power is applied to pin 3 of U1. U1 lowers the base voltage of Q215, which in turn lowers the collector voltage of A202-Q1, thereby reducing transmitter output power.

Temperature protection is provided by U1 and thermistor RT201. RT201 is mounted on the heatsink assembly. Under normal operating conditions, the temperature sensing circuit is inactive. When the heatsink temperature reaches approximately 100°C, the resistance of RT101 descreases, decreasing the base voltage of Q215. This in turn reduces the collector voltage applied to A202-Q1, reducing the transmitter output until at approximately 125°C the output power is almost zero. As the temperature of the heatsink decreases, the output power increases until full power return at approximately 100°C.

Overvoltage protection for the RF transistors is also provided by U1. Should the supply voltage exceed approximately 18 volts, U1 will switch off the collector

voltage to A202-W1, turning it off and thereby removing drive to the PA. The IC will hold A202-Q1 off until the supply voltage is reduced to a safe level.

- CAUTION -

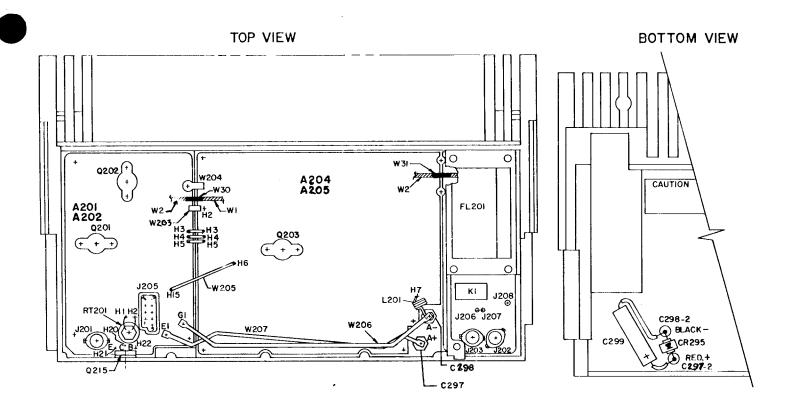
U1 may be damaged if output terminals 12 or 14 are shorted to ground. Use extreme caution when servicing the power control circuit.

### ANTENNA MATCHING UNIT

The Antenna Matching Unit is used only in continuous duty duplex stations to optimize impedance matching between the power

amplifier and the load. It consists of a Pi network (C2-C5 and L1) and a reverse directional coupler. RF from the low pass filter is applied to the Pi network through the reverse directional coupler and then to the duplexer load. The reverse directional coupler permits monitoring the reflected power by connecting a DC voltmeter across TP1 (+) and ground (-). C2 and C4 are tuned for minimum DC voltage which represents minimum reflected Power. The turns of L1 may also be spread or compressed to further reduce the DC voltage. C2, C4, and L1 should be alternately tuned until an absolute minimum voltage reading is obtained. The residual voltage reading after tuning may vary from one transmitter to the next depending on output power level, operating frequency, and the load.

### MOBILE AND INTERMITTENT DUTY STATION

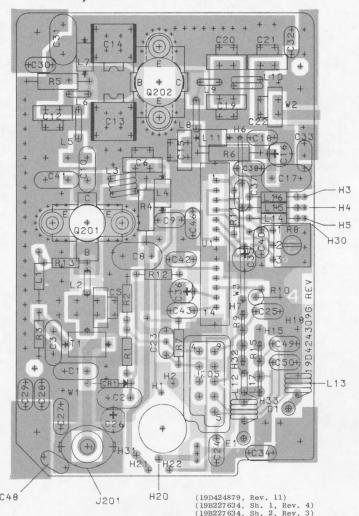


(19D429850, Rev. 1)

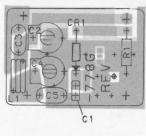
OUTLINE DIAGRAM

138-174 MHz, 65 WATT POWER AMPLIFIER

# A202, 25 WATT DRIVER



### NTENNA MATCHING UNIT

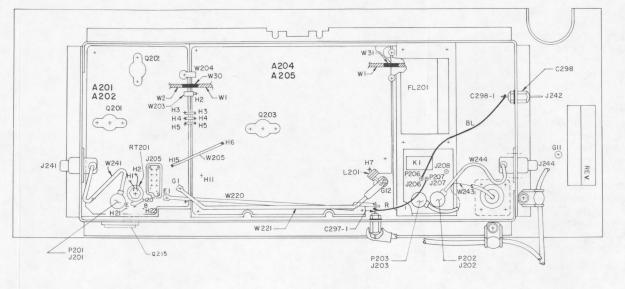


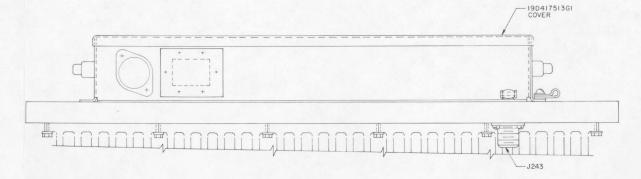
(19B233800, Rev. 0) (19A143200, Sh. 1, Rev. 0) (19A143200, Sh. 2, Rev. 0)

### **OUTLINE DIAGRAMS**

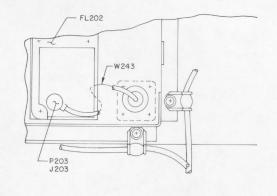
138-174 MHz, 65 WATT POWER AMPLIFIER

# STATION PA

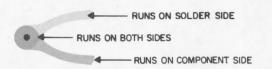




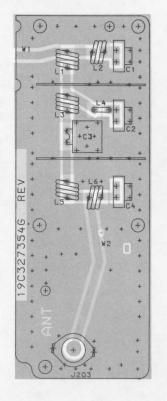
### DUPLEX STATIONS



(19D429849, Rev. 2)

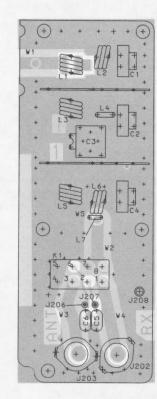


### STATION FILTER



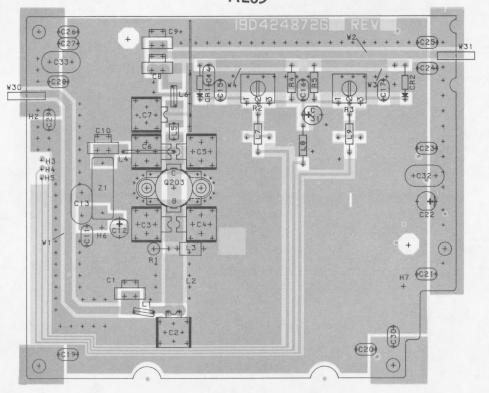
(19C327841, Rev. 1) (19B227651, Sh. 1, Rev. 0) (19B227651, Sh. 2, Rev. 0)

# MOBILE & INTERMITTENT DUTY STATION FILTER

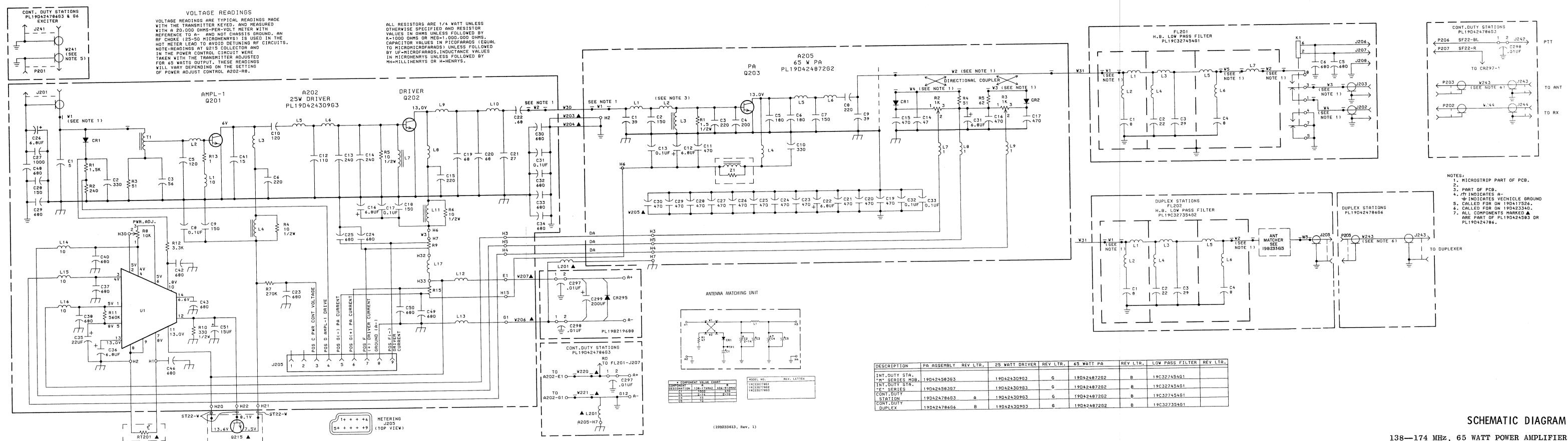


(19C327842, Rev. 1) (19B227654, Sh. 1, Rev. 1) (19B227654, Sh. 2, Rev. 1)

# A 205



(19D429838, Rev. 2) (19B232135, Sh. 1, Rev. 1) (19B232135, Sh. 2, Rev. 1)



(19R622290, Rev. 15)

Issue 3

### LBI30748

PARTS LIST PARTS LIST

138-174 MHz POWER AMPLIFIER ASSEMBLIES

19D42458361 25 WATT "M" SERIES MARINE

19D42458362 40 WATT "M" SERIES MOBILE & INT. DUTY STATION

19D42458363 41 10 WATT "M" SERIES MOBILE & INT. DUTY STATION

19D42458366 40 WATT "E" SERIES MOBILE & INT. DUTY STATION

19D42458366 40 WATT "E" SERIES MOBILE

19D42458366 65 WATT "E" SERIES MOBILE

19D42458367 65 WATT "E" SERIES MOBILE

19D42458368 110 WATT "E" SERIES MOBILE

1SDUE 8 SERIES MOBILE

1SSUE 8 SERIES

SYMBOL GE PART NO. DESCRIPTION 10 Watt Driver. (Used with 19D424583G2, G4, G6 & 19D424309G1 5 Watt Driver/PA. (Used with 19D424583G1, G3, A202 19D424309G3 19D424328G1 Coupler. (Used with 19D424583G1, G5). 40 Watt Power Amplifier. (Used with 19D424583G2, 19042487261 65 Watt Power Amplifier. (Used with 19D424583G3 A 205 19D424872G2 110 Watt Power Amplifier. (Used with A206 19D424266G1 9D424583G4 G8) COMPONENT BOARD FL201 19A116679P8D Metallized teflon: 8 pF +0.5 pF. 250 VDCW. Teflon/Mica: 22 pF ±5%, 250 VDCW. Teflon: 29 pF +5%, 250 VDCW. 19A116795P29J 19A116679P8D Metallized teflon: 8 pF ±0.5 pF, 250 VDCW. Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC 19A116655P18 ---- JACKS AND RECEPTACLES -----Connector, receptacle: 500 VDCW maximum; sim to NTTF-1058. J202 and J203 19A700049P2 19A134263P2 Contact, electrical: sim to Selectro 229-1071. J208 4033513P4 Contact, electrical: sim to Bead Chain L93-3. - - - - - - - - - RELAYS - - - - - - -Hermetic sealed: 180 to 341 ohms coil res, 8-16.3 VDC; sim to GE 3SAV1760A2, CPClare HFW-1201558, or Potter-Brumfield HCM6160. 19A700061P1 - - - - - - - - INDUCTORS - - - - - -19A129569P1 19A701418P1 19A129569P1 194701420P5 19A701418P1 L7 19A136907P1 (Part of printed board 19D424357P1).

DESCRIPTION GE PART NO. SYMBOL 19A129562P1 Coil. ----- TRANSISTORS -----Silicon, NPN: VHF Amplifier, 4 watts, 12.5 v. Q201 19A134340P1

Silicon, NPN.

Silicon, NPN.

Silicon, NPN.

Strap.

Tumner.

Jumper.

Jumper.

Jumper. 6 inches long.

Insulator, plate. (Used with Q215).

Insulator. (Located under A201, A202).

Nameplate. (110 Watt - Located on FL201). Tap screw, Phillips POZIDRIV®: No. 6-32 x 3/8.

located between FL201 cover and A203-A206 -

Lockwasher, internal tooth: No. 6. (Located between FL201 cover and A203-A206).

Tap screw, Phillips POZIDRIV®: No. 6-32 x 3/4. (Secures FL201 cover).

Machine screw: No. 4-40 x 5/8. (Secures Q1 & Q2 on A201, A202; Q1 on A204, A2095, Q1-Q3 on A206).

Nameplate. (25, 40, 65 Watt - Located on FL201).

Insulator. (Located under A203-A206).

19A134340P3

19A134340P2

19A134340P4

19A134387P1

19A134387P1

19A116742P1

19A129379G1

19A136942P1

19B227912P1

19B227931G3

19B227931G1

19B227074G1

19B226725G1

19B227934G1

19A137006P2

19A116708P1

19A115680P10

19A116783P1

19D417105G7

19A700068P1

19A700115P3

19C321982P1

19C321442P1

NP280427

NP280428

N404P13C6

N44P9010C6

19B201074P306

19B201074P312

7878455P1

Q202A

Q202B

Q203A

Q203B

Q215

RT201

W203

W204

W205

W206

W207

W208

W209

W210

W211

C299

CR295

DESCRIPTION SYMBOL GE PART NO. Machine screw, phillips head: No. 6-32 x 3/8. (Secures A201-A206 boards). N80P13006Ć6 N80P9006C6 Machine screw: No. 4-40 x 3/8. (Used with Q215 Flatwasher, steel: No. 4. (Used with Q215 N402P5C6 mounting). 7141225P2 Hex nut: No. 4-40. (Used with Q215 mounting). Silicon, NPN: VHF Amplifier, 12 watts. 19A129434P1 Washer, fiber. (Used with C297 & C298). Silicon, NPN: NHF Amplifier, 25 watts, 12.5 v. 19B219929P1 Support, heat sink. Silicon, NPN, VHF Amplifier: 45 w. Tap screw, TORZ®Drive: No. 632 x 3/8. (Secures support to heat sink - Quantity 3). 19A148393P306 19A129639P1 19B201074P305 Tap screw, Phillips POZIDRIV®: No. 6-32 x 5/16. (Secures heat sink cover). Filter casting. (FL201). 19D416275P2 Thermistor: 40K ohms  $\pm 20\%$ , color code white; sim to Carborundum Type Mo $\overline{8}06J-5$ . Lug terminal; sim to GE89473. Jumper. 5-3/4 inches long. Cable: approx 13 inches long. HEAT SINK ASSEMBLY - - - - - - - - - - CAPACITORS - - - - - - - -Ceramic: 0.01 uF -0 +100%, 500 VDCW, rated 20 amps; sim to Erie 327050X5W0103P. Electrolytic: 200 uF +150-10%, 18 VDCW; sim to Mallory Type TTX. - - - - - - DIODES AND RECTIFIERS - - - - -Rectifier, silicon: 100 VDC blocking, 6 amp; sim to MR751. ----- MISCELLANEOUS -----Heat sink. ("M" SERIES). Heat sink. ("E" SERIES). nsulator, bushing. (Used with Q215).

### PARTS LIST

138-174 MHz POWER AMPLIFIER ASSEMBLIES 19D424786G2 40 WATT CONTINUOUS DUTY STATION
19D424786G4 65 WATT CONTINUOUS DUTY STATION
19D424786G4 100 WATT CONTINUOUS DUTY STATION

SYMBOL	GE PART NO.	DESCRIPTION	
A201	19D424309G1	10 Watt Driver. (Used with 19D424786G2, G4, G5, G7).	
A202	19D424309G3	25 Watt Driver. (Used with 19D424786G3, G6).	
A204	19D424872G1	40 Watt Power Amplifier. (Used with 19D424786G2, G5).	
A205	19D424872G2	65 Watt Power Amplifier. (Used with 19D424786G3, G6).	
A206	19D424266G1	110 Watt Power Amplifier. (Used with 19D42478664, G7).	
C297	19A116708P1		
and C298	19411670821	Ceramic: 0.01 uF -0 +100%, 500 VDCW, rated 20 amps; sim to Erie 327050X5W0103P.	
FL201		COMPONENT BOARD 19C327454G1	
C1	19A116679P8D	Metallized teflon: 8 pF ±0.5 pF, 250 VDCW.	
C2	19A700015P12	Teflon/Mica: 22 pF ±5%, 250 VDCW.	
С3	19A116795P29J	Teflon: 29 pF ±5%, 250 VDCW.	
C4	19A116679P8D	Metallized teflon: 8 pF ±0.5 pF, 250 VDCW.	
C5 and C6	19A116655P18	Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.	
J202 and J203	19A700049P2	Connector, receptacle: 500 VDCW maximum; sim to NTTF-1058.	
J206 and J207	19A134263P2	Contact, electrical: sim to Selectro 229-1071.	
J208	4033513P4	Contact, electrical: sim to Bead Chain L93-3.	
		RELAYS	
К1	19A700061P1	Hermetic sealed: 180 to 341 ohms coil res, 8-16.3 VDC; sim to GE 3SAV1760A2, CPClare HFW-1201558, or Potter-Brumfield HCM6160.	
		INDUCTORS	İ
L1	19A129569P1	Coil.	
L2	19A701418P1	Coil.	
L3	19A129569P1	Coil.	1
L4	19A701420P5	Coil.	FI
L5	19A129569P1	Coil.	"
L6	19A701418P1	Coil.	
L7	19A126907P1	Coil.	
W1		(Part of printed board 19D424357P1).	
thru W5			

SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
FL202*		ANTENNA FILTER W MATCHER			JACKS AND RECEPTACLES			MISCELLANEOUS
		19C327354G2 (Added by REV. B)	J203	19A130924G1	Connector, receptacle: coaxial, jack type; sim to Cinch 14H11613.		19C321982P1	Insulator. (Located under A201 & A202).
		ANTENNA FILTER 19D432248G1			INDUCTORS		19C321442P1 19B219404G1	Insulator. (Located under A204-A206).  Shield electrical. (Located under FL201 casting).
			L1	19A129569P1 19A129570P1	Coil.		19D416275P2	Filter casting. (FL201).
C1	19A116679P8D	Metallized teflon: 8 pF ±0.5 pF, 250 VDCW.	L2 L3	19A129570P1	Coil.		19D417513G1	PA Cover.
C2	19A700015P12	Teflon/Mica: 22 pF ±5%, 250 VDCW.	L4	19A129575P1	Coil.		19B226212G1	Heat sink. (The 3 center heat sinks on 75, 100, 110 WATT & the only 2 heat sinks on the 40, 65
C3	19A116795P29J	Teflon: 29 pF ±5%, 250 VDCW.	L5	19A129569P1	Coil.			WATT power amplifiers).
C4	19A116679P8D	Metallized teflon: 8 pF ±0.5 pF, 250 VDCW.	re	19A129570P1	Coil.		19B226212G2	Heat sink. (Located on J243 end of the 75, 100, 110 WATT Power amplifiers - Quantity 1).
		JACKS AND RECEPTACLES					19B226212G3	Heat sink. (Located on W241 end of the 75, 100, 110 WATT Power amplifiers - Quantity 1).
J1 thru	19A116364P2	Contact, electrical; sim to AMP 86182-7.	W1		(Part of printed board 19D424362P1).		7150186P127	Spacer. (Termination for L201 & W221).
J4 J203	19A700049P2	Connector, receptacle: 500 VDCW maximum; sim to	and W2				N529P18C6	Plug button. (Used when C298 is not used -
0200	15470004512	NTTF-1058.					19A701863P13	Duplex).  Cable clip. (Located near J243 - Quantity 2).
			L201	19A129562P4	Coil.		19B209268P113	Terminal, solderless: sim to AMP 2-34835-4.
L1	19A129569P1	Coil.	L202	19A129562P3	Coil.			(Solders to C297-2).
L2	19A701418P1	Coil.					7491823P13	Terminal, solderless. (Used on power ground wire at PA).
L3	19A129569P1	Coil.	P206	4036634P1	Contact, electrical; sim to AMP 42428-2.		7139898P3	Nut, hex, brass: No. 1/4-28. (Secures C297 & C298).
L4 L5	19A701420P5 19A129569P1	Coil.					N80P13016C6	Machine screw, phillips head: No. 6-32 x 1.
L6	19A729569P1 19A701418P1	Coil.	Q201	19A134340P1	Silicon, NPN: VHF Amplifier, 4 watts, 12.5 v.		19B201074P308	(Secures FL201 casting - Quantity 5).  Tap screw, Phillips POZIDRIV®: No. 6-32 x 1/2.
			Q202A	19A134340P3	Silicon, NPN: VHF Amplifier, 12 watts.		1982010742305	(Located between FL201 casting and A204-A206 - Grounds FL201 shield).
			Q202B	19A134340P2	Silicon, NPN: NHF Amplifier, 25 watts, 12.5 v.		N44P9010C6	Machine screw: No. 4-40 x 5/8. (Secures Q1, Q2
W1 thru W3		(Part of printed circuit board 19D432086P1).	Q203A Q203B	19A134340P4 19A134387P1	Silicon, NPN, VHF Amplifier: 45 w. Silicon, NPN.		1000010740000	on A201 & A202, Q1-Q3 on A204-A2060.
			Q204	19A134387P1	Silicon, NPN.		19B201074P320	Tap screw, Phillips POZIDRIV®: No. 6-32 x 1-1/4. (Secures L201 & W221 at spacer).
		ANTENNA MATCHER 19C330778G1	and Q205				19B201074P204	Tap screw, phillips POZIDRIV®: No. 4-40 x 1/4. (Secures J243 & J244).
	,		Q215	19A116753P1	Silicon, NPN; sim to Type 2N5302.		19B209103P410	Tap screw, hex head: No. 8-32 x 5/8. (Secures heat sinks).
C1A	19A116192P1	Ceramic: 0.01 uF ±20%, 50 VDCW; sim to Erie 8121		19A116742P1	Earlier than REV A: Silicon, NPN.		19B201074P306	Tap screw, Phillips POZIDRIV®: No. 6-32 x 3/8.
C2	19A700008P2	Special.  Variable: 2.28 to 14.13 pF; sim to EF Johnson		194110742F1				(Secures cable clip loops and power ground terminal).
СЗА	19A116656P15J0	187-0109-005.  Ceramic disc: 15 pF ±5%, 500 VDCW, temp coef	RT201	19A129379G1	Thermistor: 40K ohms +20%, color code white; sim		19A134260P1 4029974P1	Insulator cover. (Used with Q215).  Insulator, plate: aluminum. (Used with Q215).
}		O PPM.			to Carborundum Type M0806J-5.		19A115222P3	Washer, shield. (Used with Q215).
C4A	19A700008P2	Variable: 2.28 to 14.13 pF; sim to EF Johnson 187-0109-005.					4036994P1	Terminal, solderless. (Used with Q215).
C5A	19A116656P10J0	Ceramic disc: 10 pF ±0.5 pF, 500 VDCW, temp coef 0 PPM.	W203	19A136942P1	Strap.		N210P9C6	Hex nut, steel: No. 4-40. (Secures Q215).
			W204	7878455P1	Lug terminal; sim to GE89473.			
on 1	10170001700	DIODES AND RECTIFIERS	W205 W210	19B227912P1 19B227934G1	Jumper.			
CR1	19A700047P3	Silicon: 100 mW; sim to 1N6263.	W211	19A137006P2	Cable: approx 13 inches long.  Jumper.			
			W220	19B227931G2	Jumper.			
L1A	19A143343P1	Coil.	W221	19B227931G4	Jumper.			
			W243		CABLE ASSEMBLY			
R1	19A700106P31	Composition: 47 ohms ±5%, 1/4 w.			19A129312G6			
FL202*		COMPONENT BOARD			JACKS AND RECEPTACLES			
		19C327354G1 (Deleted by REV. B)	J203	19A700067P1	Connector. Includes:  Receptacle, coax; sim to Amphenol 83-798.			
				4029082P2	Cover.			
C1	19A116679P8D	Metallized teflon: 8 pF ±0.5 pF, 250 VDCW.						
C2	19A700015P12	Teflon/Mica: 22 pF ±5%, 250 VDCW.	P203	5491689P108	Plug. (Includes 10 inches of RF cable).			·
С3	19A116795P29J	Teflon: 29 pF ±5%, 250 VDCW.	₩244	5491689P108 5491689P104	Cable, RF: approx 4 inches long. (Includes			
C4	19A116679P8D	Metallized teflon: 8 pF ±0.5 pF, 250 VDCW.	"	2-2-3007.204	J244).			
					]			

### PARTS LIST

A205 138-174 MHz, 65 WATT POWER AMPLIFIER 19D424872G2 REV B ISSUE 4

SYMBOL	GE PART NO.	DESCRIPTION
C1B	19A700015P19	Teflon/Mica: 39 pF ±5%, 250 VDCW.
С2В	19A116795P150J	Mica: 150 pF ±5%, 250 VDCW.
СЗВ	19A700014P37	Metallized teflon: 220 pF ±5%, 250 VDCW.
C4B	19A700014P36	Metallized teflon: 200 pF ±5%, 250 VDCW.
C5 and C6	19A700014P35	Metallized teflon: 180 pF ±5%, 250 VDCW.
С7В	19A700014P33	Metallized teflon: 150 pF ±5%, 250 VDCW.
C8	19A700015P37	Teflon/Mica: 220 pF ±5%, 250 VDCW.
С9В	19A700015P19	Teflon/Mica: 39 pF <u>+</u> 5%, 250 VDCW.
C10B	19A700015P41	Teflon/Mica: 330 pF ±5%, 250 VDCW.
C11	19A116655P13	Ceramic disc: 470 pF ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C12	19A134202P15	Tantalum: 6.8 uF ±20%, 35 VDCW.
C13	19A116080P107	Polyester: 0.1 uF ±10%, 50 VDCW.
C14B	19A700105P26	Mica: 47 pF ±5%, 500 VDCW.
C15 thru C17	19A116655P13	Ceramic disc: 470 pF $\pm 20\%$ , 1000 VDCW; sim to RMC Type JF Discap.
C19 thru C21	19A116655P13	Ceramic disc: 470 pF ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C22	19A134202P15	Tantalum: 6.8 uF <u>+</u> 20%, 35 VDCW.
C23 thru	19A116655P13	Ceramic disc: 470 pF ±20%, 1000 VDCW; sim to RMC Type JF Discap.
C30	19A134202P15	Tantalum: 6.8 uF +20%, 35 VDCW.
C32	19A134202P13	Polyester: 0.1 uF ±10%, 50 VDCW,
and C33		
		DIODES AND RECTIFIERS
CR1 and CR2	19A116052P2	Silicon, fast recovery; sim to Hewlett Packard 5082-2811.
L1B	19A136533P1	Coil.
L2		(Part of printed board 19D424845P1).
L3	19A701091G1	Coil.
L4B	19A136716P2	Coil.
L5B	19A130270P2	Coil.
L6B	19A136533P1	Coil.
L7 thru L9	19A700024P13	Coil, RF: 1.0 uH ±10%.
		RESISTORS
2124		
R1B*	7147161P17	Composition: 1.5 ohms ±5%, 1/2 w.
	opggp1007	Earlier than REV A:
	3R77P100J	Composition: 10 ohms ±5%, 1/2 w.
R2 and R3	19A700109P1	Variable, cermet: 1K ohms ±20%, 1/4 w.
R4	19A700106P32	Composition: 51 ohms ±5%, 1/4 w.
R5B	3R152P620J	Composition: 62 ohms ±5%, 1/4 w.
		·
	1	1

SYMBOL	GE PART NO.	DESCRIPTION
W1 thru W4		
W30 and W31	19A701093P2	Strap.

19B219649G1

19A129346G2 19A700112P15

19A129361P2

L1

R1

### PARTS LIST

A202 138-174 MHz, 25 WATT DRIVER/PA 19D424309G3 REV F ISSUE 4

ohms ±5%, 1 w			
Comme 15%, I w.  ***CIB***	SYMROL	GE PART NO	DESCRIPTION
CIB 18A700108P1	ides:	GETAKTIO.	DESCRIPTION
MISCHLANDOES   C2			
MISCHLANDOES   C2	10 ohms ±5%, 1 w.		
MISCELLANEOUS   C2		19A700105P1	Mica: 4.7 pF ±5%, 500 VDCW.
C3	MISCELLANEOUS C2	7489162P39	Silver mica: 330 pF ±5%, 500 VDCW; sim to
Teflon/Mics: 120 pF to 5, 250 VDCW.   In REW B a earlier:   In R			
19A116679P100J   19A116659P18   19		İ	-
19A1166799100J	CoB*	194700015P31	_
C6		19A116679P100J	
CS	<sub>C6</sub>		
C9 19A116655P8 Ceamic disc: 150 FF ±0%, 1000 VDCW; sim. to RMC Type JF Discap.  C10B 19A70015P36 Mica: 120 FF ±5%, 500 VDCW.  C12 19A70015P30 Silver mica: 110 FF ±5%, 250 VDCW.  C13B 19A700014P38 Metallized teflon: 240 FF ±5%, 250 VDCW.  C14B 19A700014P38 Metallized teflon: 240 FF ±5%, 250 VDCW.  C15 19A4700015P37 Teflon/Mica: 220 FF ±5%, 250 VDCW.  C16 19A134202P15 Tantalum: 6.8 uF ±20%, 35 VDCW.  C17 19A116655P8 Ceramic disc: 150 FF ±10%, 1000 VDCW; sim. to RMC Type JF Discap.  C19 19A700015P25 Silver mica: 68 FF ±5%, 250 VDCW.  C21B 19A700015P25 Silver mica: 68 FF ±5%, 250 VDCW.  C22B 19A700015P25 Silver mica: 68 FF ±5%, 250 VDCW.  C22B 19A700015P25 Silver mica: 68 FF ±5%, 250 VDCW.  C22B 19A700015P25 Silver mica: 68 FF ±5%, 250 VDCW.  C22B 19A134202P15 Teflon/Mica: 27 FF ±5%, 250 VDCW.  C23C 19A134202P15 Tantalum: 6.8 uF ±20%, 35 VDCW.  C25 C26 19A134202P15 Ceramic disc: 680 FF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C28 19A136655P18 Ceramic disc: 150 FF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C29 19A116655P18 Ceramic disc: 680 FF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C29 19A116655P18 Ceramic disc: 680 FF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C31 19A116655P18 Ceramic disc: 680 FF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C32 19A134202P15 Tantalum: 22 uF ±20%, 15 VDCW.  C33 19A134202P15 Tantalum: 22 uF ±20%, 15 VDCW.  C34 19A134202P15 Tantalum: 22 uF ±20%, 15 VDCW.  C35 19A134202P15 Tantalum: 22 uF ±20%, 15 VDCW.  C36 19A134202P15 Tantalum: 28 uF ±20%, 15 VDCW.  C37 19A116655P18 Ceramic disc: 680 FF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C41 19A116655P18 Ceramic disc: 680 FF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C42 19A116655P18 Ceramic disc: 680 FF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C43 19A116655P18 Ceramic disc: 680 FF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C45 19A116655P18 Ceramic disc: 680 FF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C46 19A116655P18 Ceramic disc: 680 FF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C47 19A116655P18 Ceramic disc:		1	_
Clos	C9	1	_
C12			Type JF Discap.
C138			
C14B		i	
C15		l	_
C16			
C17	1 1		
C18	<b>! !</b>	1	<del>-</del>
C19			Ceramic disc: 150 pF $\pm$ 10%, 1000 VDCW; sim. to RMC
C21B 19A700015P15 Tellon/Mica: 27 pF ±5\$, 250 VDCW.  C22B 19A700015P25 Silver mica: 68 pF ±5\$, 250 VDCW.  C23 19A116655P18 Ceramic disc: 680 pF ±10\$, 1000 VDCW; sim to RMC Type JF Discap.  C26 19A134202P15 Tantalum: 6.8 uF ±20\$, 35 VDCW.  C27 19A116655P19 Ceramic disc: 1000 pF ±20\$, 1000 VDCW; sim to RMC Type JF Discap.  C28 19A116655P18 Ceramic disc: 150 pF ±10\$, 1000 VDCW; sim to RMC Type JF Discap.  C29 19A116655P18 Ceramic disc: 680 pF ±10\$, 1000 VDCW; sim to RMC Type JF Discap.  C30 19A11605P18 Ceramic disc: 680 pF ±10\$, 1000 VDCW; sim to RMC Type JF Discap.  C31 19A11605P18 Ceramic disc: 680 pF ±10\$, 1000 VDCW; sim to RMC Type JF Discap.  C32 19A134202P6 Tantalum: 22 uF ±20\$, 35 VDCW.  C33 19A134202P1 Tantalum: 22 uF ±20\$, 35 VDCW.  C36 19A134202P1 Tantalum: 6.8 uF ±20\$, 35 VDCW.  C37 19A116655P18 Ceramic disc: 680 pF ±10\$, 1000 VDCW; sim to RMC Type JF Discap.  C40 19A116655P18 Ceramic disc: 680 pF ±10\$, 1000 VDCW; sim to RMC Type JF Discap.  C41 19A700105P11 Mica: 15 pF ±5\$, 500 VDCW.  C42 19A116655P18 Ceramic disc: 680 pF ±10\$, 1000 VDCW; sim to RMC Type JF Discap.  C44 19A10655P18 Ceramic disc: 680 pF ±10\$, 1000 VDCW; sim to RMC Type JF Discap.  C45 19A116655P18 Ceramic disc: 680 pF ±10\$, 1000 VDCW; sim to RMC Type JF Discap.  C46 19A116655P18 Ceramic disc: 680 pF ±10\$, 1000 VDCW; sim to RMC Type JF Discap.  C48 19A116655P18 Ceramic disc: 680 pF ±10\$, 1000 VDCW; sim to RMC Type JF Discap.	C19	19A700015P25	
C22B 19A700015P25 Silver mica: 68 pF ±5%, 250 VDCW.  C23 thru C25  C26 19A134202P15 Tantalum: 6.8 uF ±20%, 35 VDCW.  C27 19A116655P18 Ceramic disc: 1000 pF ±20%, 1000 VDCW; sim to RMC Type JF Discap.  C28 19A116655P8 Ceramic disc: 1000 pF ±20%, 1000 VDCW; sim to RMC Type JF Discap.  C29 19A116655P8 Ceramic disc: 150 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C29 19A116655P18 Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C31 19A116080P107 Polyester: 0.1 uF ±10%, 50 VDCW.  C32 19A13400P16 Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C34 19A134202P15 Tantalum: 22 uF ±20%, 15 VDCW.  C35 19A134202P15 Tantalum: 6.8 uF ±20%, 35 VDCW.  C36 19A134202P15 Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C37 19A116655P18 Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C40 19A116655P18 Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C41 19A700105P11 Mica: 15 pF ±5%, 500 VDCW.  C42 19A116655P18 Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C43 19A116655P18 Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C44 19A116655P18 Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C48 19A116655P18 Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C48 19A116655P18 Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C48 19A116655P18 Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C48 19A116655P18 Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.	C20B	19A700015P25	Silver mica: 68 pF ±5%, 250 VDCW.
C23 thru C25 C26 C26 C27 C27 C28 C28 C28 C28 C28 C29 C28 C29 C30 C30 C31 C30 C31 C32 C32 C34 C35 C34 C35 C36 C37 C37 C38 C38 C39 C39 C39 C39 C31 C39 C31 C39 C31 C30 C31 C31 C32 C34 C35 C36 C37 C37 C38 C38 C39 C39 C39 C39 C39 C39 C39 C31 C30 C31 C31 C30 C31 C31 C32 C34 C35 C34 C35 C36 C37 C37 C38 C38 C39 C39 C39 C39 C39 C39 C39 C30 C31 C30 C31 C30 C31 C30 C31 C30 C32 C40 C35 C40 C40 C40 C40 C40 C40 C40 C41 C41 C41 C41 C42 C42 C42 C43 C48 C48 C48 C48 C48 C48 C48 C48 C48 C48	C21B	19A700015P15	Teflon/Mica: 27 pF ±5%, 250 VDCW.
thru C25  C26  19A134202P15  Tantalum: 6.8 uF ±20%, 35 vDCw.  C27  19A116655P18  C28  19A116655P8  C29  19A116655P18  C30  C31  19A116655P18  C32  19A116655P18  C32  19A116655P18  C33  C31  19A116655P18  C32  19A116655P18  C33  C31  19A116655P18  C32  19A116655P18  C33  C32  19A116655P18  C34  C35  19A134202P6  Tantalum: 22 uF ±20%, 1000 vDCW; sim to RMC Type JF Discap.  C36  19A134202P6  Tantalum: 6.8 uF ±20%, 15 vDcw.  C37  19A116655P18  C40  19A116655P18  C41  19A116655P18  C42  19A116655P18  C43  C44  19A116655P18  C45  C46  19A116655P18  C47  C47  C48  19A11665SP18  C48  C48  19A11665SP18  C48  C48  19A11665SP18  C48  C48  19A11665SP18  C49  C48  C48  19A11665SP18  C48  C49  C48  C48  C49  C48  C48  C4	C22B	19A700015P25	Silver mica: 68 pF ±5%, 250 VDCW.
C26 19A134202P15 C27 19A116655P19 C28 19A116655P8 Ceramic disc: 1000 pF ±20%, 1000 vDCW; sim to RMC Type JF Discap. C29 19A116655P18 Ceramic disc: 150 pF ±10%, 1000 vDCW; sim to RMC Type JF Discap. C29 19A116655P18 Ceramic disc: 680 pF ±10%, 1000 vDCW; sim to RMC Type JF Discap. C30 Polyester: 0.1 uF ±10%, 50 vDcW. C31 19A116655P18 Ceramic disc: 680 pF ±10%, 1000 vDcW; sim to RMC Type JF Discap. C34 C35 19A134202P6 Tantalum: 22 uF ±20%, 15 vDcW. C36 19A134202P15 Tantalum: 6.8 uF ±20%, 35 vDcW. C37 19A116655P18 Ceramic disc: 680 pF ±10%, 1000 vDcW; sim to RMC Type JF Discap. C40 19A16655P18 Ceramic disc: 680 pF ±10%, 1000 vDcW; sim to RMC Type JF Discap. C41 19A700105P11 Mica: 15 pF ±5%, 500 vDcW. C42 and C43 Ceramic disc: 680 pF ±10%, 1000 vDcW; sim to RMC Type JF Discap. C46 19A116655P18 Ceramic disc: 680 pF ±10%, 1000 vDcW; sim to RMC Type JF Discap. C48 19A116655P18 Ceramic disc: 680 pF ±10%, 1000 vDcW; sim to RMC Type JF Discap. C48 19A116655P18 Ceramic disc: 680 pF ±10%, 1000 vDcW; sim to RMC Type JF Discap. C48 19A116655P18 Ceramic disc: 680 pF ±10%, 1000 vDcW; sim to RMC Type JF Discap. C48 19A116655P18 Ceramic disc: 680 pF ±10%, 1000 vDcW; sim to RMC Type JF Discap. C48 19A116655P18 Ceramic disc: 680 pF ±10%, 1000 vDcW; sim to RMC Type JF Discap.	thru	19A116655P18	
C27	1 1	19A134202P15	Tantalum: 6.8 uF +20%, 35 VDCW.
RMC Type JF Discap.   Ceramic disc: 150 pF ±10%, 1000 VDCW; sim. to RMC Type JF Discap.	C27	19A116655P19	Ceramic disc: 1000 pF ±20%, 1000 VDCW; sim to
C29 and C30  C31  19A116655P18  C32  thru C34  C35  19A134202P6  C36  19A116655P18  C37  and C38  C40  19A116655P18  C41  19A700105P11  C42 and C43  C46  19A116655P18  C48  19A116655P18  C62  C62  C630  C640  19A116655P18  C640  19A116655P18  C641  19A116655P18  C642 and C643  C646  19A116655P18  C648  19A116655P18  C648  19A116655P18  C648  C649  C640  C640  C640  C640  C640  C641  C640  C6	C28	19A116655P8	RMC Type JF Discap.  Ceramic disc: 150 pF ±10%, 1000 VDCW; sim. to RMC
C31		19A116655P18	Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC
C32 thru C34  C35  19A134202P6  C36  19A134202P15  C37 and C38  C40  19A116655P18  C41  19A700105P11  C42 and C43  C46  19A116655P18  C48  19A116655P18  C48  19A116655P18  C6ramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C48  19A116655P18  C6ramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C41  19A700105P11  C62  19A116655P18  C63  C646  C646  C648		194116080D107	Delucation, 0.1 NF 110% 50 UDOW
C34  C35  19A134202P6  Tantalum: 22 uF ±20%, 15 VDCW.  C36  19A134202P15  Tantalum: 6.8 uF ±20%, 35 VDCW.  C37  and  C38  C40  19A116655P18  Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C41  19A700105P11  Mica: 15 pF ±5%, 500 VDCW.  C42  and  C43  C44  19A116655P18  Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C47  C48  19A116655P18  Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C48  19A116655P18  Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C48  19A116655P18  Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C48  Type JF Discap.	C32		Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC
C36  19A134202P15  Tantalum: 6.8 uF ±20%, 35 VDCW.  C37 and C38  C40  19A116655P18  C41  19A700105P11  C42 and C43  C42  19A116655P18  C43  C44  19A116655P18  C45  C45  19A116655P18  C46  19A116655P18  C47  C48 C48  19A116655P18  C48  C48  C48  C48  C48  C48  C48  C	C34		
C37 and C38  C40  19A116655P18  Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C41  19A700105P11  C42 and C43  C46  19A116655P18  Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C47  Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C48  19A116655P18  Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C48  19A116655P18  Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C48  19A116655P18  Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.			<u> </u>
and C38  C40  19A116655P18  Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C41  19A700105P11  Mica: 15 pF ±5%, 500 VDCW.  C42 and C43  C46  19A116655P18  Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C48  19A116655P18  Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C48  19A116655P18  Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C48  19A116655P18  Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.		1	<del>-</del>
Type JF Discap.  C41	and	194110055118	Type JF Discap.
C42 and C43 Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C46 19A116655P18 Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C48 19A116655P18 Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.	C40	19A116655P18	Ceramic disc: 680 pF $\pm$ 10%, 1000 VDCW; sim to RMC Type JF Discap.
and C43  C46  19A116655P18  Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.  C48  19A116655P18  Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC Type JF Discap.	C41	19A700105P11	Mica: 15 pF ±5%, 500 VDCW.
Type JF Discap.  C48 19A116655P18 Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC thru Type JF Discap.	and	19A116655P18	
thru Type JF Discap.	C46	19A116655P18	
	thru	19A116655P18	Ceramic disc: 680 pF ±10%, 1000 VDCW; sim to RMC

	SYMBOL	GE PART NO.	DESCRIPTION	
	C51*	19B209723P5	Tantalum: 15 uF ±20%, 20 VDCW. Added by REV D. Deleted by REV E.	I
		19A116679P10J0	Metallized teflon: 10 pF ±5%, 250 VDCW. Added by REV B. Deleted by REV C.	
	CR1	19A115250P1	DIODES AND RECTIFIERS	
-	Eİ	19A134263P1	Contact, electrical: sim to Selectro 229-1082-00-0-590.	
-	G1	19A134263P1	Contact, electrical: sim to Selectro 229-1082-00-0-590.	
	J201 J205	19A700049P2	Connector, receptacle; 500 VDCW maximum; sim to NTTF-1058.	
		10001001101		
	L1	19A700024P25		4
	L2*	19A137270P2	Coil, RF: 10.0 uH ±10%, 3.70 ohms DC res max.  Coil. Added by REV B. Deleted by REV C.	
	L3A	19A136530P1	Coil.	
мс	L4	19A701091G1	Coil.	
	L5B	19A136532P1	Coil.	
	L6	19A701420P5	Coil,	
	L7	19A701091G1	Coil.	
ŀ	L8B	19A136531P1	Coil.	
	L9B	19A701420P5	Coil.	İ
	L10B	19A136533P1	Coil.	
	L11 L12	19A701091G1	Coil.	
мС	L13	19A129569P1 19A701419P3	Coil.	
	L14 thru L16	19A700024P25	Coil, RF: 10.0 uH ±10%, 3.70 ohms DC res max.	
	L17	19A701420P5	Coil.	
MC			RESISTORS	
	R1	19A700106P67	Composition: 1.5K ohms ±5%, 1/4 w.	
	R2	3R152P241J	Composition: 240 ohms $\pm 5\%$ , 1/4 w.	
	R3	19A700106P32	Composition: 51 ohms ±5%, 1/4 w.	
мс	R4 thru R6	19A700113P15	Composition: 10 ohms ±5%, 1/2 w.	
MC	R7	3R152P274J	Composition: 270K ohms ±5%, 1/4 w.	
	R8A	19A116655P106	Variable, cermet: 10K ohms ±20%, 0.5 w; sim to CTS Series 360.	
MC	R9 R10	19C850605P2 19A700113P51	Shunt resistor.	
	R11	3R152P564J	Composition: 330 ohms ±5%, 1/2 w.  Composition: 560K ohms ±5%, 1/4 w.	
	R12	19A700106P75	Composition: 3.3K ohms ±5%, 1/4 w.	
	R13	19A116216P1ROJ	Deposited carbon: 1.0 ohms ±5%, 1/4 w; sim to	
мс	R15	19C850605P2	Mepco Electra Type CR25. Shunt resistor.	
MC			TRANSFORMERS	
	T1	19A129564G1	Transformer.	
MC			INTEGRATED CIRCUITS	
	U1*	19D429709G3	IC, Power Control.	
MC			In REV D & earlier:	
viC		19D429709G3	IC, Power Control.	

SYMBOL	GE PART NO.	DESCRIPTION
W1 and W2		(Part of printed board 19D424308P1).
<b>V</b> 3	198227912P1	Jumper.
		MISCELLANEOUS
	19A701093P2	Strap. (Solders to W2).

### **PRODUCTION CHANGES**

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter," which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

REV. A - D - 25 Watt Driver PA Assembly 19D424309G3

Incorporated in initial shipment.

REV. A - 65 Watt Power Amplifier 19D424872G2, A205 To improve performance. Changed RIA and RIB.

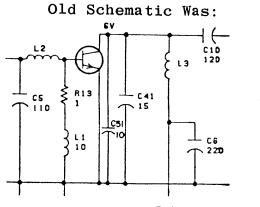
REV. A - 25 Watt Driver 19D424309G3

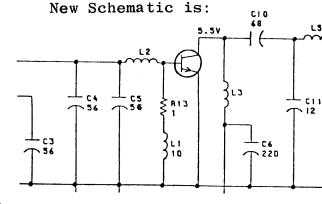
To improve operation when Solid Stae Scientific, Inc. (SSS) transistors are used for Q201. Delete C39. Change C11 and add L2.

REV. B - To improve operation when Communication Transistor Corp. (CTC) transistors are used for Q201. Delete C39, add L2. Changed C11 and added C51.

REV. C - To improve operation when TRW transistors are used for Q201.

Deleted C51 and L2. Added C39 and changed C11.





REV. D - To improve operation of power control circuit. Added C51.

REV. E - To delete components not required with improved Power Control IC. Deleted C51.

REV. F - To increase Power output at high end. Change ClB and C5B.
Deleted C39. Added L2 (replaced C39 with L2).
ClB was: 19A700105P8 - Mica: 12 pf ±5%, 500 VDCW.
C5B was: 19A700105P29 - Metallized teflon: 100 pf ±5%, 250 VDCW.
In REV. B and earlier.
19A116679P100J - Silver mica: 100 pf ±5%, 250 VDCW.
C39 was: 19A116655P18 - Ceramic disc: 680 pf ±10%, 1000 VDCW; sim
to RMC Type JF Discap. Deleted by REV. A. Added by REV. C.

REV. B - Power Amplifier Module 19D424872G2

To increase power output at high end. Changed ClB. ClB was: 19A700015P17 - Metallized teflon: 33 pf ±5%, 250 VDCW.

REV. A - 65-Watt Continuous Duty Duplex Stations 19D424786G3, G6

To incorporate new transistor. Changed Q215.

REV. B - To incorporate new Antenna Matching unit FL202 on low pass filter board. FL202 was: 19C327354Gl.

\*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES.